

"CERTIFICATE OF TRANSMISSION under 37 CFR 1.8"

I hereby certify that this correspondence is being facsimile transmitted to the United States Commissioner for Patent and Trademark Office, Washington, D.C. 20231, on April 2, 2002.

Typed or Printed Name of Person Signing Certificate: Shirley G. Shepard

Signature: Shirley G. Shepard

PATENT
Docket No. P1406

IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: SERGEY LOPATIN

SERIAL NO.: 10/081,074

EXAMINER: UNKNOWN

FILED: FEBRUARY 21, 2002

ART UNIT: 2812

FOR: CHEMICAL SOLUTION FOR ELECTROPLATING A
COPPER-ZINC ALLOY THIN FILM

COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

REQUEST FOR CORRECTED FILING RECEIPT

1. Attached is a copy of the original Filing Receipt. We respectfully request issuance of a corrected filing receipt.

2. There is an error in:

- ☐ Applicant's name and/or address
- ☒ Title (One to many t in Electroplating).
- ☐ Filing Date
- ☐ Serial Number
- ☐ Foreign/PCT Application
- ☒ Other (Assignment for Published Patent Application name should be capitalize (i.e. "A").

It should read as follows: Advanced Micro Devices, Inc., Sunnyvale, CA.

In support of this request, faxed herewith is a copy of the original filing receipt showing errors.

28/2
#3/CFR
Andrew
8/29/02

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/081,074	02/21/2002	2812	740	P1406	3	20	3

CONFIRMATION NO. 2324

FILING RECEIPT



OC00000007870976

LaRiviere, Grubman & Payne, LLP
P.O. Box 3140
Monterey, CA 93942

Date Mailed: 03/19/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Sergey Lopatin, Santa Clara, CA;

Assignment For Published Patent Application

A advanced Micro Devices, Inc., Sunnyvale, CA;

Domestic Priority data as claimed by applicant

Foreign Applications

If Required, Foreign Filing License Granted 03/19/2002

Projected Publication Date: Request for Non-Publication Acknowledged

Non-Publication Request: Yes

Early Publication Request: No

Title

Chemical solution for electroplating a copper-zinc alloy thin film

Preliminary Class

438

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